

Welcome to **E-XFL.COM** 

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

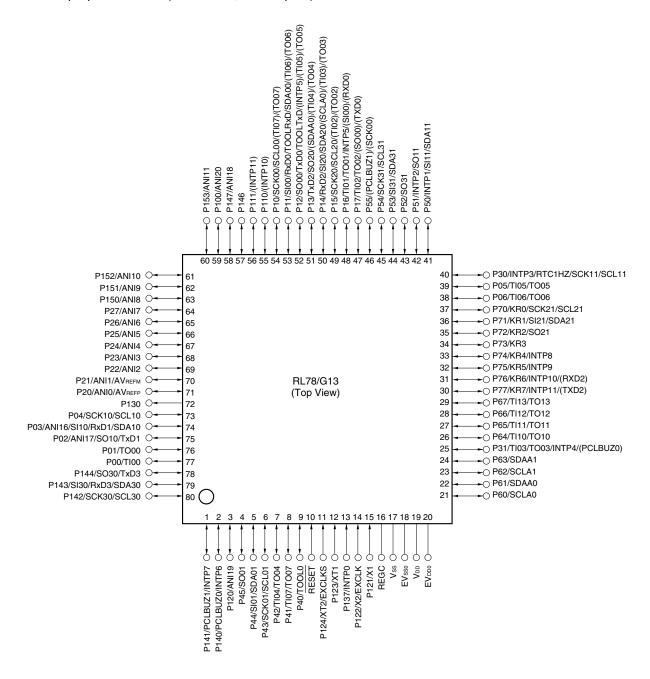
Details	
Product Status	Obsolete
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	22
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	3K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-WFQFN Exposed Pad
Supplier Device Package	32-HWQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f100bddna-u0

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

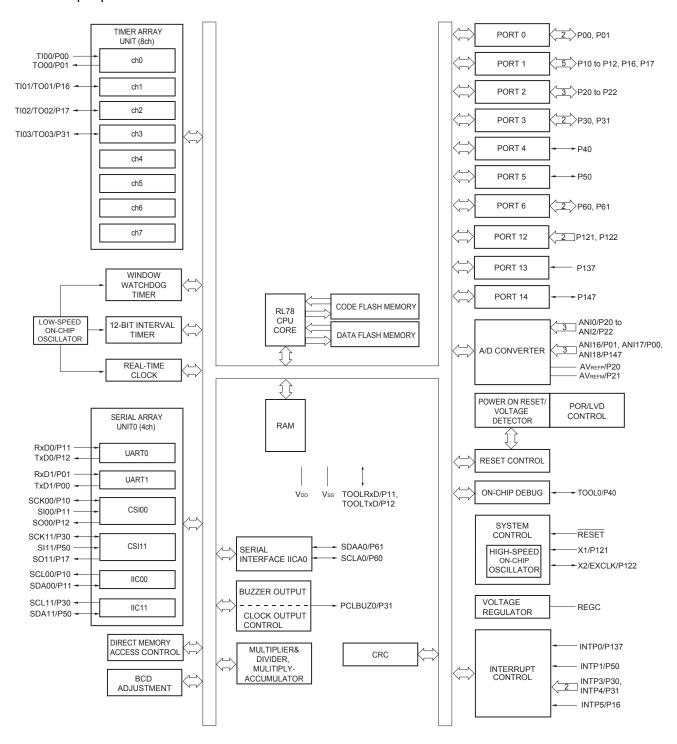
### 1.3.12 80-pin products

- 80-pin plastic LQFP (14 × 14 mm, 0.65 mm pitch)
- 80-pin plastic LFQFP (12 x 12 mm, 0.5 mm pitch)

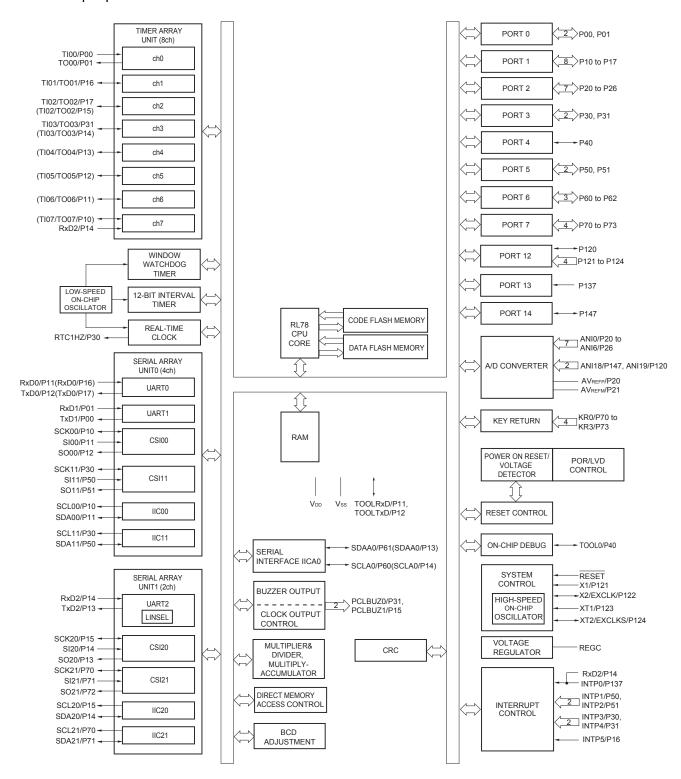


- Cautions 1. Make EVsso pin the same potential as Vss pin.
  - 2. Make VDD pin the potential that is higher than EVDDO pin.
  - 3. Connect the REGC pin to Vss via a capacitor (0.47 to 1  $\mu$ F).
- Remarks 1. For pin identification, see 1.4 Pin Identification.
  - 2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V<sub>DD</sub> and EV<sub>DD0</sub> pins and connect the Vss and EV<sub>SS0</sub> pins to separate ground lines.
  - **3.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register** (**PIOR**) in the RL78/G13 User's Manual.

## 1.5.2 24-pin products



## 1.5.7 40-pin products



Remark Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR) in the RL78/G13 User's Manual.

**3.** The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves) (see **6.9.3 Operation as multiple PWM output function** in the RL78/G13 User's Manual).

4. When setting to PIOR = 1

11	<b>n</b>	n	١
14	ر2	_	ı

Ite	m	20-	pin	24-	pin	25-	pin	30-	-pin	32	-pin	36	pin
		R5F1006x	R5F1016x	R5F1007x	R5F1017x	R5F1008x	R5F1018x	R5F100Ax	R5F101Ax	R5F100Bx	R5F101Bx	R5F100Cx	R5F101Cx
Clock output/buzze	er output	- 1 1 2 2 2									2		
				88 kHz, 9 n clock: f				ИHz, 5 N	IHz, 10 N	МНz		•	
8/10-bit resolution	A/D converter	6 chanr	nels	6 chanı	nels	6 chanı	nels	8 chan	nels	8 chan	nels	8 chan	nels
Serial interface		[20-pin,	24-pin,	25-pin p	roducts]								
		• CSI:	1 chann	el/simpli	fied I <sup>2</sup> C:	1 channe	el/UART	: 1 chanı	nel				
		• CSI:	1 chann	el/simpli	fied I <sup>2</sup> C:	1 channe	el/UART	: 1 chanı	nel				
		[30-pin,	32-pin <sub> </sub>	products	]								
		• CSI:	1 chann	el/simplit el/simplit el/simplit	fied I <sup>2</sup> C:	1 channe	el/UART	: 1 chanı	nel	ng LIN-bi	us): 1 ch	annel	
		[36-pin	products	s]									
		• CSI:	1 chann	el/simplit el/simplit els/simpl	fied I <sup>2</sup> C:	1 channe	el/UART	: 1 chanı	nel	rtina LIN	-bus): 1	channel	
	I <sup>2</sup> C bus			1 chanı		1 chanı		1 chan		1 chan		1 chan	nel
Multiplier and divid	der/multiply-	<ul> <li>• 16 bits × 16 bits = 32 bits (Unsigned or signed)</li> <li>• 32 bits ÷ 32 bits = 32 bits (Unsigned)</li> <li>• 16 bits × 16 bits + 32 bits = 32 bits (Unsigned or signed)</li> </ul>											
DMA controller		2 chanr	nels										
Vectored interrupt	Internal	2	23	2	24	2	24	2	27	2	27	2	27
sources	External	;	3		5		5		6		6		6
Key interrupt				•				_					
Reset		<ul><li>Interr</li><li>Interr</li><li>Interr</li><li>Interr</li><li>Interr</li></ul>	nal reset nal reset nal reset nal reset	SET pin by watc by power by volta by illega by illega by illega	er-on-res ge detec al instruc I parity e	set ctor tion exec rror		e					
Power-on-reset circuit  • Power-on-reset: 1.51 V (TYP.)  • Power-down-reset: 1.50 V (TYP.)													
Voltage detector			g edge : ig edge			4.06 V ( 3.98 V (	_						
On-chip debug fun	ection	Provide	ed										
Power supply volta	age	V <sub>DD</sub> = 1	.6 to 5.5	V (T <sub>A</sub> =	-40 to +8	35°C)							
		$V_{DD} = 2$	4 to 5.5	V (T <sub>A</sub> = -	40 to +1	05°C)							
Operating ambient	t temperature			C (A: Co i°C (G: Ir				ndustria	l applica	tions )			
		14 - 40	10 T 100	. o (a. 11	idudilidi	αμμποαι	0110)						

Note The illegal instruction is generated when instruction code FFH is executed.

Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.

- Notes 1. Total current flowing into V<sub>DD</sub> and EV<sub>DDO</sub>, including the input leakage current flowing when the level of the input pin is fixed to V<sub>DD</sub>, EV<sub>DDO</sub> or V<sub>SS</sub>, EV<sub>SSO</sub>. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  - 2. During HALT instruction execution by flash memory.
  - 3. When high-speed on-chip oscillator and subsystem clock are stopped.
  - 4. When high-speed system clock and subsystem clock are stopped.
  - **5.** When high-speed on-chip oscillator and high-speed system clock are stopped. When RTCLPC = 1 and setting ultra-low current consumption (AMPHS1 = 1). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
  - 6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  - **7.** Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode:  $2.7 \text{ V} \le V_{DD} \le 5.5 \text{ V} @ 1 \text{ MHz to } 32 \text{ MHz}$   $2.4 \text{ V} \le V_{DD} \le 5.5 \text{ V} @ 1 \text{ MHz to } 16 \text{ MHz}$  LS (low-speed main) mode:  $1.8 \text{ V} \le V_{DD} \le 5.5 \text{ V} @ 1 \text{ MHz to } 8 \text{ MHz}$ 

LV (low-voltage main) mode: 1.6 V  $\leq$  VDD  $\leq$  5.5 V @ 1 MHz to 4 MHz

- **8.** Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.
- Remarks 1. fmx: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fin: High-speed on-chip oscillator clock frequency
  - 3. fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - **4.** Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is T<sub>A</sub> = 25°C

# (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products

# (Ta = -40 to +85°C, 1.6 V $\leq$ EVDD0 = EVDD1 $\leq$ VDD $\leq$ 5.5 V, Vss = EVss0 = EVss1 = 0 V) (2/2)

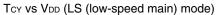
Parameter	Symbol			Conditions		MIN.	TYP.	MAX.	Unit
Supply	DD2 Note 2	HALT	HS (high-	fin = 32 MHz Note 4	V <sub>DD</sub> = 5.0 V		0.62	1.86	mA
Current Note 1	Note 2	mode	speed main) mode Note 7		V <sub>DD</sub> = 3.0 V		0.62	1.86	mA
			mode	fih = 24 MHz Note 4	V <sub>DD</sub> = 5.0 V		0.50	1.45	mA
					V <sub>DD</sub> = 3.0 V		0.50	1.45	mA
				fih = 16 MHz Note 4	V <sub>DD</sub> = 5.0 V		0.44	1.11	mA
					V <sub>DD</sub> = 3.0 V		0.44	1.11	mA
			LS (low-	fin = 8 MHz Note 4	V <sub>DD</sub> = 3.0 V		290	620	μA
			speed main) mode Note 7		V <sub>DD</sub> = 2.0 V		290	620	μΑ
			LV (low-	f <sub>IH</sub> = 4 MHz <sup>Note 4</sup>	V <sub>DD</sub> = 3.0 V		440	680	μΑ
			voltage main) mode		V <sub>DD</sub> = 2.0 V		440	680	μΑ
			HS (high-	f <sub>MX</sub> = 20 MHz <sup>Note 3</sup> ,	Square wave input		0.31	1.08	mA
			speed main) mode Note 7	V <sub>DD</sub> = 5.0 V	Resonator connection		0.48	1.28	mA
				$f_{MX} = 20 \text{ MHz}^{Note 3},$	Square wave input		0.31	1.08	mA
				V <sub>DD</sub> = 3.0 V	Resonator connection		0.48	1.28	mA
				$f_{MX} = 10 \text{ MHz}^{\text{Note 3}},$	Square wave input		0.21	0.63	mA
				V <sub>DD</sub> = 5.0 V	Resonator connection		0.28	0.71	mA
				f <sub>M</sub> x = 10 MHz <sup>Note 3</sup> ,	Square wave input		0.21	0.63	mA
				V <sub>DD</sub> = 3.0 V	Resonator connection		0.28	0.71	mA
			LS (low-	f <sub>M</sub> x = 8 MHz <sup>Note 3</sup> ,	Square wave input		110	360	μА
			speed main) mode Note 7	V <sub>DD</sub> = 3.0 V	Resonator connection		160	420	μΑ
				fmx = 8 MHz <sup>Note 3</sup> ,	Square wave input		110	360	μΑ
				V <sub>DD</sub> = 2.0 V	Resonator connection		160	420	μΑ
			Subsystem	fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		0.28	0.61	μΑ
			clock operation	T <sub>A</sub> = -40°C	Resonator connection		0.47	0.80	μΑ
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		0.34	0.61	μΑ
				T <sub>A</sub> = +25°C	Resonator connection		0.53	0.80	μΑ
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		0.41	2.30	μΑ
				T <sub>A</sub> = +50°C	Resonator connection		0.60	2.49	μΑ
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		0.64	4.03	μΑ
				T <sub>A</sub> = +70°C	Resonator connection		0.83	4.22	μА
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		1.09	8.04	μΑ
				T <sub>A</sub> = +85°C	Resonator connection		1.28	8.23	μА
	IDD3 <sup>Note 6</sup>	STOP	T <sub>A</sub> = -40°C				0.19	0.52	μΑ
		mode <sup>Note 8</sup>	T <sub>A</sub> = +25°C				0.25	0.52	μΑ
			T <sub>A</sub> = +50°C				0.32	2.21	μΑ
			T <sub>A</sub> = +70°C				0.55	3.94	μΑ
			T <sub>A</sub> = +85°C				1.00	7.95	μA

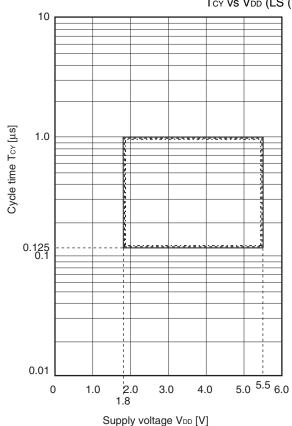
(Notes and Remarks are listed on the next page.)



- **6.** Current flowing only to the A/D converter. The supply current of the RL78 microcontrollers is the sum of IDD1 or IDD2 and IADC when the A/D converter operates in an operation mode or the HALT mode.
- 7. Current flowing only to the LVD circuit. The supply current of the RL78 microcontrollers is the sum of IDD1, IDD2 or IDD3 and ILVD when the LVD circuit is in operation.
- 8. Current flowing only during data flash rewrite.
- 9. Current flowing only during self programming.
- 10. For shift time to the SNOOZE mode, see 18.3.3 SNOOZE mode.
- Remarks 1. fil: Low-speed on-chip oscillator clock frequency
  - 2. fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - 3. fclk: CPU/peripheral hardware clock frequency
  - **4.** Temperature condition of the TYP. value is  $T_A = 25^{\circ}C$

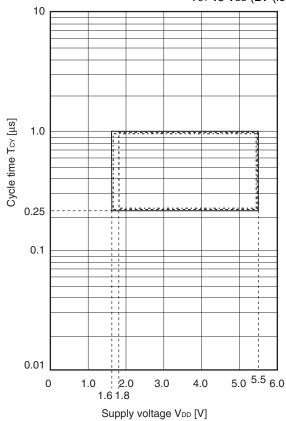






- When the high-speed on-chip oscillator clock is selected
- During self programming
   When high-speed system clock is selected

## Tcy vs Vdd (LV (low-voltage main) mode)



- When the high-speed on-chip oscillator clock is selected During self programming
- --- When high-speed system clock is selected

## (5) During communication at same potential (simplified I<sup>2</sup>C mode) (2/2)

(Ta = -40 to +85°C, 1.6 V  $\leq$  EVDD0 = EVDD1  $\leq$  VDD  $\leq$  5.5 V, Vss = EVss0 = EVss1 = 0 V)

Parameter	Symbol	Conditions	` `	h-speed Mode	`	r-speed Mode	`	-voltage Mode	Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Data setup time (reception)	tsu:dat	$2.7~V \leq EV_{DD0} \leq 5.5~V,$ $C_b = 50~pF,~R_b = 2.7~k\Omega$	1/f <sub>MCK</sub> + 85 <sub>Note2</sub>		1/f <sub>MCK</sub> + 145 <sub>Note2</sub>		1/f <sub>MCK</sub> + 145 <sub>Note2</sub>		ns
		$1.8~V \leq EV_{DD0} \leq 5.5~V,$ $C_b = 100~pF,~R_b = 3~k\Omega$	1/fmck + 145 Note2		1/f <sub>MCK</sub> + 145 <sub>Note2</sub>		1/f <sub>MCK</sub> + 145 <sub>Note2</sub>		ns
		$1.8~V \leq EV_{DD0} < 2.7~V,$ $C_b = 100~pF,~R_b = 5~k\Omega$	1/fmck + 230 Note2		1/fmck + 230 Note2		1/fmck + 230 Note2		ns
		$1.7~V \leq EV_{DD0} < 1.8~V,$ $C_b = 100~pF,~R_b = 5~k\Omega$	1/fmck + 290 Note2		1/fmck + 290 Note2		1/fmck + 290 Note2		ns
		$1.6~V \leq EV_{DD0} < 1.8~V,$ $C_b = 100~pF,~R_b = 5~k\Omega$	_		1/fmck + 290 Note2		1/fmck + 290 Note2		ns
Data hold time (transmission)	thd:dat	$2.7~V \leq EV_{DD0} \leq 5.5~V,$ $C_b = 50~pF,~R_b = 2.7~k\Omega$	0	305	0	305	0	305	ns
		$1.8 \text{ V} \leq \text{EV}_{\text{DD0}} \leq 5.5 \text{ V},$ $C_{\text{b}} = 100 \text{ pF}, \text{ Rb} = 3 \text{ k}\Omega$	0	355	0	355	0	355	ns
		1.8 V $\leq$ EV <sub>DD0</sub> $<$ 2.7 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ	0	405	0	405	0	405	ns
		$1.7 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 5 \text{ k}\Omega$	0	405	0	405	0	405	ns
		$1.6~V \leq EV_{DD0} < 1.8~V,$ $C_b = 100~pF,~R_b = 5~k\Omega$	_	_	0	405	0	405	ns

Notes 1. The value must also be equal to or less than fmck/4.

2. Set the fmck value to keep the hold time of SCLr = "L" and SCLr = "H".

Caution Select the normal input buffer and the N-ch open drain output (Vpb tolerance (When 20- to 52-pin products)/EVpb tolerance (When 64- to 128-pin products)) mode for the SDAr pin and the normal output mode for the SCLr pin by using port input mode register g (PIMg) and port output mode register h (POMh).

(Remarks are listed on the next page.)

# (7) Communication at different potential (2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only) (1/2)

(Ta = -40 to +85°C, 2.7 V  $\leq$  EVDD0 = EVDD1  $\leq$  VDD  $\leq$  5.5 V, Vss = EVss0 = EVss1 = 0 V)

Parameter	Symbol		Conditions	HS (hig		LS (low main)	-speed	LV (low- main)	•	Unit
					MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	tkcy1	tkcy1 ≥ 2/fclk	$ \begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 20 \; pF, \; R_b = 1.4 \\ &k\Omega \end{aligned} $	200		1150		1150		ns
			$\begin{split} & 2.7 \; \text{V} \leq \text{EV}_{\text{DD0}} < 4.0 \; \text{V}, \\ & 2.3 \; \text{V} \leq \text{V}_{\text{b}} \leq 2.7 \; \text{V}, \\ & C_{\text{b}} = 20 \; \text{pF}, \; R_{\text{b}} = 2.7 \\ & \text{k}\Omega \end{split}$	300		1150		1150		ns
SCKp high-level width	tкнı	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 6$ $C_{b} = 20 \text{ pF, F}$	4.0 V,	tксү1/2 — 50		tксу1/2 — 50		tксү1/2 — 50		ns
		$2.7 \text{ V} \leq \text{EV}_{DD}$ $2.3 \text{ V} \leq \text{V}_{b} \leq 2.0 \text{ pF, F}$	2.7 V,	tксу1/2 — 120		tксу1/2 — 120		tксу1/2 — 120		ns
SCKp low-level width	tĸL1	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 6$ $C_{b} = 20 \text{ pF, F}$	4.0 V,	tксү1/2 — 7		t <sub>KCY1</sub> /2 – 50		t <sub>KCY1</sub> /2 – 50		ns
		$2.3~V \leq V_b \leq 3$	$2.7 \text{ V} \le \text{EV}_{\text{DD0}} < 4.0 \text{ V},$ $2.3 \text{ V} \le \text{V}_{\text{b}} \le 2.7 \text{ V},$ $C_{\text{b}} = 20 \text{ pF}, R_{\text{b}} = 2.7 \text{ k}\Omega$			tксү1/2 — 50		tксү1/2 — 50		ns
SIp setup time (to SCKp↑) Note 1	tsıĸı	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 4$ $C_{b} = 20 \text{ pF, F}$	4.0 V,	58		479		479		ns
		$2.7 \text{ V} \leq \text{EV}_{DD}$ $2.3 \text{ V} \leq \text{V}_{b} \leq 2$ $C_{b} = 20 \text{ pF, F}$	2.7 V,	121		479		479		ns
SIp hold time (from SCKp↑) Note 1	tksi1	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 4$ $C_{b} = 20 \text{ pF, F}$	4.0 V,	10		10		10		ns
		$2.7 \text{ V} \le \text{EV}_{DD}$ $2.3 \text{ V} \le \text{V}_{b} \le 3$ $C_{b} = 20 \text{ pF}, \text{ F}$	2.7 V,	10		10		10		ns
Delay time from SCKp↓ to SOp output Note 1	tkso1	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 4.0 \text{ C}$ $C_{b} = 20 \text{ pF, F}$	o ≤ 5.5 V, 4.0 V,		60		60		60	ns
		$2.7 \text{ V} \le \text{EV}_{DD}$ $2.3 \text{ V} \le \text{V}_{b} \le 2$ $C_{b} = 20 \text{ pF, F}$	o < 4.0 V, 2.7 V,		130		130		130	ns

(Notes, Caution, and Remarks are listed on the next page.)

# (10) Communication at different potential (1.8 V, 2.5 V, 3 V) (simplified $I^2C$ mode) (1/2)

(Ta = -40 to +85°C, 1.8 V  $\leq$  EVDD0 = EVDD1  $\leq$  VDD  $\leq$  5.5 V, Vss = EVss0 = EVss1 = 0 V)

Parameter	Symbol	Conditions	, -	h-speed Mode	,	v-speed Mode	,	-voltage Mode	Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLr clock frequency	fscL	$\begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 50 \; pF, \; R_b = 2.7 \; k\Omega \end{aligned}$		1000 Note 1		300 Note 1		300 Note 1	kHz
		eq:second-seco		1000 Note 1		300 Note 1		300 Note 1	kHz
		$ \begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 100 \; pF, \; R_b = 2.8 \; k\Omega \end{aligned} $		400 Note 1		300 Note 1		300 Note 1	kHz
		$\label{eq:section} \begin{split} 2.7 \ V & \leq EV_{DD0} < 4.0 \ V, \\ 2.3 \ V & \leq V_b \leq 2.7 \ V, \\ C_b & = 100 \ pF, \ R_b = 2.7 \ k\Omega \end{split}$		400 Note 1		300 Note 1		300 ote 1	kHz
		$\begin{split} &1.8~V \leq EV_{DD0} < 3.3~V,\\ &1.6~V \leq V_b \leq 2.0~V^{\text{Note 2}},\\ &C_b = 100~pF,~R_b = 5.5~k\Omega \end{split}$		300 Note 1		300 Note 1		300 Note 1	kHz
Hold time when SCLr = "L"	tLOW	$ \begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 50 \; pF, \; R_b = 2.7 \; k\Omega \end{aligned} $	475		1550		1550		ns
		eq:second-seco	475		1550		1550		ns
		$ \begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 100 \; pF, \; R_b = 2.8 \; k\Omega \end{aligned} $	1150		1550		1550		ns
		$\label{eq:section} \begin{split} 2.7 \ V & \leq EV_{DD0} < 4.0 \ V, \\ 2.3 \ V & \leq V_b \leq 2.7 \ V, \\ C_b & = 100 \ pF, \ R_b = 2.7 \ k\Omega \end{split}$	1150		1550		1550		ns
		$\begin{split} &1.8~V \leq EV_{DD0} < 3.3~V,\\ &1.6~V \leq V_b \leq 2.0~V^{\text{Note 2}},\\ &C_b = 100~pF,~R_b = 5.5~k\Omega \end{split}$	1550		1550		1550		ns
Hold time when SCLr = "H"	tнівн	$ 4.0 \ V \le EV_{DD0} \le 5.5 \ V, $ $ 2.7 \ V \le V_b \le 4.0 \ V, $ $ C_b = 50 \ pF, \ R_b = 2.7 \ k\Omega $	245		610		610		ns
		$ 2.7 \text{ V} \leq \text{EV}_{\text{DDO}} < 4.0 \text{ V}, \\ 2.3 \text{ V} \leq \text{V}_{\text{b}} \leq 2.7 \text{ V}, \\ C_{\text{b}} = 50 \text{ pF}, \text{ R}_{\text{b}} = 2.7 \text{ k}\Omega $	200		610		610		ns
		$ \begin{aligned} & 4.0 \text{ V} \leq \text{EV}_{\text{DD0}} \leq 5.5 \text{ V}, \\ & 2.7 \text{ V} \leq \text{V}_{\text{b}} \leq 4.0 \text{ V}, \\ & C_{\text{b}} = 100 \text{ pF}, \text{ R}_{\text{b}} = 2.8 \text{ k}\Omega \end{aligned} $	675		610		610		ns
		$ 2.7 \text{ V} \leq \text{EV}_{\text{DDO}} < 4.0 \text{ V}, \\ 2.3 \text{ V} \leq \text{V}_{\text{b}} \leq 2.7 \text{ V}, \\ C_{\text{b}} = 100 \text{ pF}, \text{ R}_{\text{b}} = 2.7 \text{ k}\Omega $	600		610		610		ns
		$\begin{split} &1.8~V \leq EV_{DDO} < 3.3~V,\\ &1.6~V \leq V_b \leq 2.0~V^{\text{Note 2}},\\ &C_b = 100~pF,~R_b = 5.5~k\Omega \end{split}$	610		610		610		ns

**Notes 1.** The first clock pulse is generated after this period when the start/restart condition is detected.

<R>

2. The maximum value (MAX.) of thd:DAT is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

Caution The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (IoH1, IoL1, VOH1, VOL1) must satisfy the values in the redirect destination.

**Remark** The maximum value of Cb (communication line capacitance) and the value of Rb (communication line pull-up resistor) at that time in each mode are as follows.

Standard mode:  $C_b = 400 \text{ pF}, R_b = 2.7 \text{ k}\Omega$ 



#### 3.3 DC Characteristics

#### 3.3.1 Pin characteristics

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.4 \text{ V} \le \text{EV}_{DD0} = \text{EV}_{DD1} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{Vss} = \text{EV}_{SS0} = \text{EV}_{SS1} = 0 \text{ V}) (1/5)$ 

Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Output current, high <sup>Note 1</sup>	Іон1	Per pin for P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V			-3.0 Note 2	mA
		Total of P00 to P04, P07, P32 to P37,	$4.0~V \leq EV_{DD0} \leq 5.5~V$			-30.0	mA
		P40 to P47, P102 to P106, P120,	$2.7 \text{ V} \le \text{EV}_{\text{DDO}} < 4.0 \text{ V}$			-10.0	mA
		P125 to P127, P130, P140 to P145 (When duty ≤ 70% Note 3)	$2.4 \text{ V} \leq \text{EV}_{\text{DD0}} < 2.7 \text{ V}$			-5.0	mA
		Total of P05, P06, P10 to P17, P30, P31,				-30.0	mA
		P50 to P57, P64 to P67, P70 to P77, P80	$2.7~V \leq EV_{DD0} < 4.0~V$			-19.0	mA
		to P87, P90 to P97, P100, P101, P110 to P117, P146, P147 $(\mbox{When duty} \leq 70\%^{\mbox{Note 3}})$	2.4 V ≤ EVDD0 < 2.7 V			-10.0	mA
		Total of all pins (When duty $\leq 70\%^{\text{Note 3}}$ )	$2.4~V \le EV_{DD0} \le 5.5~V$			-60.0	mA
	1он2	Per pin for P20 to P27, P150 to P156	$2,4~V \leq V_{DD} \leq 5.5~V$			-0.1 <sup>Note 2</sup>	mA
		Total of all pins (When duty ≤ 70% <sup>Note 3</sup> )	$2.4~V \leq V_{DD} \leq 5.5~V$			-1.5	mA

- **Notes 1**. Value of current at which the device operation is guaranteed even if the current flows from the EV<sub>DD0</sub>, EV<sub>DD1</sub>, V<sub>DD</sub> pins to an output pin.
  - 2. Do not exceed the total current value.
  - **3.** Specification under conditions where the duty factor  $\leq 70\%$ .

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

• Total output current of pins =  $(IOH \times 0.7)/(n \times 0.01)$ 

<Example> Where n = 80% and  $I_{OH} = -10.0$  mA

Total output current of pins =  $(-10.0 \times 0.7)/(80 \times 0.01) \cong -8.7$  mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

Caution P00, P02 to P04, P10 to P15, P17, P43 to P45, P50, P52 to P55, P71, P74, P80 to P82, P96, and P142 to P144 do not output high level in N-ch open-drain mode.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

- Notes 1. Total current flowing into VDD and EVDDO, including the input leakage current flowing when the level of the input pin is fixed to VDD, EVDDO or Vss, EVsso. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  - 2. When high-speed on-chip oscillator and subsystem clock are stopped.
  - 3. When high-speed system clock and subsystem clock are stopped.
  - **4.** When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  - **5.** Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode:  $2.7 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V} @ 1 \text{ MHz}$  to 32 MHz  $2.4 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V} @ 1 \text{ MHz}$  to 16 MHz

- Remarks 1. fmx: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fin: High-speed on-chip oscillator clock frequency
  - 3. fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - 4. Except subsystem clock operation, temperature condition of the TYP. value is TA = 25°C

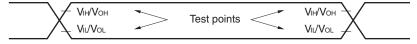
# (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (Ta = -40 to $+105^{\circ}$ C, 2.4 V $\leq$ EV<sub>DD0</sub> = EV<sub>DD1</sub> $\leq$ V<sub>DD</sub> $\leq$ 5.5 V, Vss = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V) (1/2)

Parameter	Symbol			Conditions			MIN.	TYP.	MAX.	Unit
Supply	I <sub>DD1</sub>	Operating	HS (high-	fin = 32 MHz Note 3	Basic	V <sub>DD</sub> = 5.0 V		2.3		mA
Current Note 1		mode	speed main) mode Note 5		operatio n	V <sub>DD</sub> = 3.0 V		2.3		mA
					Normal	V <sub>DD</sub> = 5.0 V		5.2	9.2	mA
					operatio n	V <sub>DD</sub> = 3.0 V		5.2	9.2	mA
				fih = 24 MHz <sup>Note 3</sup>	Normal	V <sub>DD</sub> = 5.0 V		4.1	7.0	mA
					operatio n	V <sub>DD</sub> = 3.0 V		4.1	7.0	mA
				fin = 16 MHz <sup>Note 3</sup>	Normal	V <sub>DD</sub> = 5.0 V		3.0	5.0	mA
					operatio n	V <sub>DD</sub> = 3.0 V		3.0	5.0	mA
			HS (high-	$f_{MX} = 20 \text{ MHz}^{\text{Note 2}},$	Normal	Square wave input		3.4	5.9	mA
			speed main) mode Note 5	V <sub>DD</sub> = 5.0 V	operatio n	Resonator connection		3.6	6.0	mA
				$f_{MX} = 20 \text{ MHz}^{\text{Note 2}},$	Normal	Square wave input		3.4	5.9	mA
				V <sub>DD</sub> = 3.0 V	operatio n	Resonator connection		3.6	6.0	mA
				$f_{MX} = 10 \text{ MHz}^{\text{Note 2}},$	Normal	Square wave input		2.1	3.5	mA
				V <sub>DD</sub> = 5.0 V	operatio n	Resonator connection		2.1	3.5	mA
				$f_{MX} = 10 \text{ MHz}^{\text{Note 2}},$	Normal	Square wave input		2.1	3.5	mA
				V <sub>DD</sub> = 3.0 V	operatio n	Resonator connection		2.1	3.5	mA
			Subsystem	fsub = 32.768 kHz	Normal	Square wave input		4.8	5.9	μΑ
			clock operation	$T_A = -40^{\circ}C$	operatio n	Resonator connection		4.9	6.0	μΑ
				fsub = 32.768 kHz	Normal	Square wave input		4.9	5.9	μΑ
				T <sub>A</sub> = +25°C	operatio n	Resonator connection		5.0	6.0	μΑ
				fsub = 32.768 kHz	Normal	Square wave input		5.0	7.6	μΑ
				T <sub>A</sub> = +50°C	operatio n	Resonator connection		5.1	7.7	μΑ
				fsub = 32.768 kHz	Normal	Square wave input		5.2	9.3	μΑ
				Note 4  TA = +70°C	operatio n	Resonator connection		5.3	9.4	μА
				fsuB = 32.768 kHz	Normal	Square wave input		5.7	13.3	μΑ
				Note 4 $T_A = +85^{\circ}C$	operatio n	Resonator connection		5.8	13.4	μΑ
				fsuв = 32.768 kHz	Normal	Square wave input		10.0	46.0	μΑ
				Note 4  TA = +105°C	operatio n	Resonator connection		10.0	46.0	μΑ

(Notes and Remarks are listed on the next page.)

### 3.5 Peripheral Functions Characteristics

#### **AC Timing Test Points**



#### 3.5.1 Serial array unit

#### (1) During communication at same potential (UART mode)

 $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.4 \text{ V} \le \text{EV}_{DD0} = \text{EV}_{DD1} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{Vss} = \text{EV}_{SS0} = \text{EV}_{SS1} = 0 \text{ V})$ 

Parameter	Symbol	Conditions	HS (high-spee	ed main) Mode	Unit
			MIN.	MAX.	
Transfer rate Note 1				fmck/12 Note 2	bps
		Theoretical value of the maximum transfer rate fclk = 32 MHz, fMck = fclk		2.6	Mbps

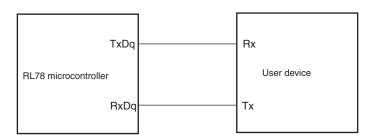
Notes 1. Transfer rate in the SNOOZE mode is 4800 bps only.

2. The following conditions are required for low voltage interface when EVDDO < VDD.

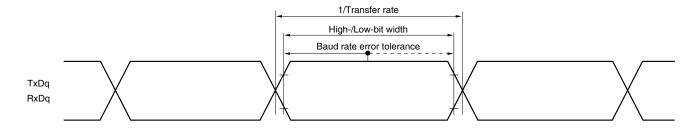
 $2.4 \text{ V} \leq \text{EV}_{\text{DD0}} < 2.7 \text{ V}$ : MAX. 1.3 Mbps

Caution Select the normal input buffer for the RxDq pin and the normal output mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg).

#### UART mode connection diagram (during communication at same potential)



#### **UART** mode bit width (during communication at same potential) (reference)



**Remarks 1.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)

2. fmck: Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number,
n: Channel number (mn = 00 to 03, 10 to 13))

# (2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output) $(T_A = -40 \text{ to } +105^{\circ}\text{C}, 2.4 \text{ V} \le \text{EV}_{\text{DD0}} = \text{EV}_{\text{DD1}} \le 5.5 \text{ V}, \text{Vss} = \text{EV}_{\text{SS0}} = \text{EV}_{\text{SS1}} = 0 \text{ V})$

Parameter	Symbol	Conditions		HS (high-spee	ed main) Mode	Unit
				MIN.	MAX.	
SCKp cycle time	tkcy1	tkcy1 ≥ 4/fclk	$2.7~V \leq EV_{\text{DD0}} \leq 5.5~V$	250		ns
			$2.4~V \leq EV_{DD0} \leq 5.5~V$	500		ns
SCKp high-/low-level width	<b>t</b> кн1,	4.0 V ≤ EV <sub>DD</sub>	<sub>00</sub> ≤ 5.5 V	tkcy1/2 - 24		ns
	t <sub>KL1</sub>	2.7 V ≤ EV <sub>DD</sub>	<sub>00</sub> ≤ 5.5 V	tkcy1/2 - 36		ns
		2.4 V ≤ EV <sub>DD</sub>	<sub>00</sub> ≤ 5.5 V	tkcy1/2 - 76		ns
SIp setup time (to SCKp↑) Note 1	tsıĸ1	4.0 V ≤ EV <sub>DD</sub>	<sub>00</sub> ≤ 5.5 V	66		ns
		2.7 V ≤ EV <sub>DD</sub>	<sub>00</sub> ≤ 5.5 V	66		ns
		2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		113		ns
SIp hold time (from SCKp↑) Note 2	<b>t</b> KSI1			38		ns
Delay time from SCKp↓ to SOp output Note 3	tkso1	C = 30 pF Note	o 4		50	ns

- **Notes 1.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp setup time becomes "to SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - 2. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - 3. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
  - 4. C is the load capacitance of the SCKp and SOp output lines.

Caution Select the normal input buffer for the SIp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

- **Remarks 1.** p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3).
  - g: PIM and POM numbers (g = 0, 1, 4, 5, 8, 14)
  - 2. fmck: Serial array unit operation clock frequency
    - (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number,
    - n: Channel number (mn = 00 to 03, 10 to 13))

## 3.6 Analog Characteristics

### 3.6.1 A/D converter characteristics

Classification of A/D converter characteristics

		Reference Voltage	
	Reference voltage (+) = AVREFP	Reference voltage (+) = VDD	Reference voltage (+) = V <sub>BGR</sub>
Input channel	Reference voltage (–) = AVREFM	Reference voltage (-) = Vss	Reference voltage (–) = AVREFM
ANI0 to ANI14	Refer to <b>3.6.1 (1)</b> .	Refer to <b>3.6.1 (3)</b> .	Refer to <b>3.6.1 (4)</b> .
ANI16 to ANI26	Refer to <b>3.6.1 (2)</b> .		
Internal reference voltage	Refer to <b>3.6.1 (1)</b> .		-
Temperature sensor output			
voltage			

(1) When reference voltage (+) = AVREFP/ANIO (ADREFP1 = 0, ADREFP0 = 1), reference voltage (-) = AVREFM/ANI1 (ADREFM = 1), target pin : ANI2 to ANI14, internal reference voltage, and temperature sensor output voltage

(TA = -40 to +105°C, 2.4 V  $\leq$  AVREFP  $\leq$  VDD  $\leq$  5.5 V, Vss = 0 V, Reference voltage (+) = AVREFP, Reference voltage (-) = AVREFM = 0 V)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Resolution	RES			8		10	bit
Overall error <sup>Note 1</sup>	AINL	10-bit resolution AV <sub>REFP</sub> = V <sub>DD</sub> Note 3	$2.4 \text{ V} \leq \text{AV}_{\text{REFP}} \leq 5.5 \text{ V}$		1.2	±3.5	LSB
Conversion time	tconv	10-bit resolution	$3.6~V \leq V_{DD} \leq 5.5~V$	2.125		39	μs
		Target pin: ANI2 to ANI14	$2.7~\text{V} \leq \text{Vdd} \leq 5.5~\text{V}$	3.1875		39	μS
			$2.4~V \leq V_{DD} \leq 5.5~V$	17		39	μs
		10-bit resolution Target pin: Internal reference voltage, and temperature sensor output voltage (HS (high-speed main) mode)	$3.6~V \leq V_{DD} \leq 5.5~V$	2.375		39	μs
			$2.7~V \leq V_{DD} \leq 5.5~V$	3.5625		39	μs
			$2.4~V \leq V \text{DD} \leq 5.5~V$	17		39	μs
Zero-scale error <sup>Notes 1, 2</sup>	Ezs	10-bit resolution AV <sub>REFP</sub> = V <sub>DD</sub> Note 3	$\begin{array}{c} 2.4 \ V \leq AV_{REFP} \leq 5.5 \\ V \end{array}$			±0.25	%FSR
Full-scale error <sup>Notes 1, 2</sup>	Ers	10-bit resolution AV <sub>REFP</sub> = V <sub>DD</sub> Note 3	$\begin{array}{c} 2.4 \ V \leq AV_{REFP} \leq 5.5 \\ V \end{array}$			±0.25	%FSR
Integral linearity error	ILE	10-bit resolution AVREFP = VDD Note 3	$\begin{array}{c} 2.4 \ V \leq AV_{REFP} \leq 5.5 \\ V \end{array}$			±2.5	LSB
Differential linearity error	DLE	10-bit resolution AV <sub>REFP</sub> = V <sub>DD</sub> Note 3	$\begin{array}{c} 2.4 \ V \leq AV_{REFP} \leq 5.5 \\ V \end{array}$			±1.5	LSB
Analog input voltage	VAIN	ANI2 to ANI14		0		AVREFP	V
		Internal reference voltage output (2.4 V $\leq$ VDD $\leq$ 5.5 V, HS (high-speed main) mode)  Temperature sensor output voltage (2.4 V $\leq$ VDD $\leq$ 5.5 V, HS (high-speed main) mode)		V <sub>BGR</sub> Note 4			V
				V <sub>TMPS25</sub> Note 4			V

(Notes are listed on the next page.)



### 4.7 40-pin Products

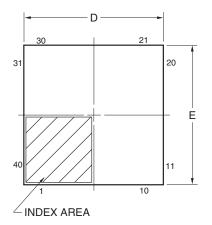
R5F100EAANA, R5F100ECANA, R5F100EDANA, R5F100EEANA, R5F100EFANA, R5F100EGANA, R5F100EHANA R5F101EAANA, R5F101ECANA, R5F101EDANA, R5F101EEANA, R5F101EFANA, R5F101EGANA, R5F101EHANA R5F100EADNA, R5F100ECDNA, R5F100EDNA, R5F100EDNA, R5F100EFDNA, R5F100EGDNA,

R5F100EHDNA

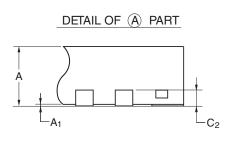
R5F101EADNA, R5F101ECDNA, R5F101EDDNA, R5F101EEDNA, R5F101EFDNA, R5F101EGDNA, R5F101EHDNA

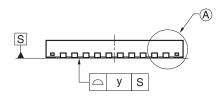
R5F100EAGNA, R5F100ECGNA, R5F100EDGNA, R5F100EEGNA, R5F100EFGNA, R5F100EGGNA, R5F100EHGNA

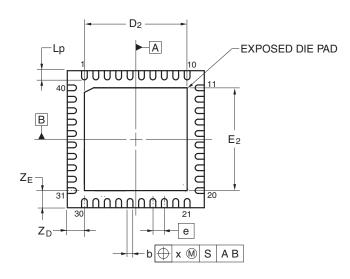
JEITA Package code		RENESAS code	Previous code	MASS (TYP.) [g]	
	P-HWQFN40-6x6-0.50	PWQN0040KC-A	P40K8-50-4B4-5	0.09	











Referance	Dimension in Millimeters			
Symbol	Min	Nom	Max	
D	5.95	6.00	6.05	
Е	5.95	6.00	6.05	
А			0.80	
A <sub>1</sub>	0.00	_		
b	0.18	0.25	0.30	
е		0.50		
Lp	0.30	0.40	0.50	
х	_		0.05	
у			0.05	
Z <sub>D</sub>		0.75		
Z <sub>E</sub>		0.75		
C <sub>2</sub>	0.15	0.20	0.25	
D <sub>2</sub>		4.50		
E <sub>2</sub>		4.50		

©2013 Renesas Electronics Corporation. All rights reserved.

		Description		
Rev.	Date	Page	Summary	
3.00	Aug 02, 2013	118	Modification of table in 2.6.2 Temperature sensor/internal reference voltage characteristics	
		118	Modification of table and note in 2.6.3 POR circuit characteristics	
		119	Modification of table in 2.6.4 LVD circuit characteristics	
		120	Modification of table of LVD Detection Voltage of Interrupt & Reset Mode	
		120	Renamed to 2.6.5 Power supply voltage rising slope characteristics	
		122	Modification of table, figure, and remark in 2.10 Timing Specs for Switching Flash Memory Programming Modes	
		123	Modification of caution 1 and description	
		124	Modification of table and remark 3 in Absolute Maximum Ratings (T <sub>A</sub> = 25°C)	
		126	Modification of table, note, caution, and remark in 3.2.1 X1, XT1 oscillator characteristics	
		126	Modification of table in 3.2.2 On-chip oscillator characteristics	
		127	Modification of note 3 in 3.3.1 Pin characteristics (1/5)	
		128	Modification of note 3 in 3.3.1 Pin characteristics (2/5)	
		133	Modification of notes 1 and 4 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products (1/2)	
		135	Modification of notes 1, 5, and 6 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products (2/2)	
		137	Modification of notes 1 and 4 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (1/2)	
		139	Modification of notes 1, 5, and 6 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (2/2)	
		140	Modification of (3) Peripheral Functions (Common to all products)	
		142	Modification of table in 3.4 AC Characteristics	
		143	Addition of Minimum Instruction Execution Time during Main System Clock Operation	
		143	Modification of figure of AC Timing Test Points	
		143	Modification of figure of External System Clock Timing	
		145	Modification of figure of AC Timing Test Points	
		145	Modification of description, note 1, and caution in (1) During communication at same potential (UART mode)	
		146	Modification of description in (2) During communication at same potential (CSI mode)	
		147	Modification of description in (3) During communication at same potential (CSI mode)	
		149	Modification of table, note 1, and caution in (4) During communication at same potential (simplified I <sup>2</sup> C mode)	
		151	Modification of table, note 1, and caution in (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2)	
		152 to 154	Modification of table, notes 2 to 6, caution, and remarks 1 to 4 in (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (2/2)	
		155	Modification of table in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (1/3)	
		156	Modification of table and caution in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (2/3)	
		157, 158	Modification of table, caution, and remarks 3 and 4 in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (3/3)	
		160, 161	Modification of table and caution in (7) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode)	